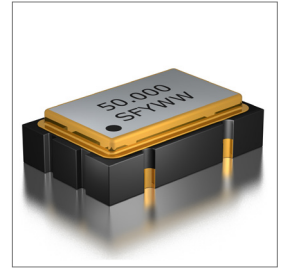


Features
• $\pm 20$ ppm (Frequency Stability) Available
• Ceramic Package
• CMOS
• Tape and Reel

Applications
• Micro Processors
• SONET/SDH/DWDM
• Storage Area/Networking
• Digital Video
• Base Stations



**Part Numbering Guide**

**SXO 53 C 3 A 48 1 X - 50.000M**

SUNTSU OSC					FREQUENCY MHz
5.0mm x 3.2mm					LOAD BLANK : 15pF X : 30pF Y : 50pF
CMOS					TRI-STATE (ENABLE/DISABLE) BLANK : No Connection 1 : Pin 1
SUPPLY VOLTAGE		FREQUENCY STABILITY	OPERATING TEMPERATURE RANGE		
1 : 1.8V $\pm$ 5%		A : $\pm$ 50ppm	07 : 0°C - +70°C		
2 : 2.5V $\pm$ 5%		B : $\pm$ 30ppm	16 : -10°C - +60°C		
3 : 3.3V $\pm$ 5%		C : $\pm$ 25ppm	17 : -10°C - +70°C		
		*D : $\pm$ 20ppm	27 : -20°C - +70°C		
			38 : -30°C - +85°C		
			48 : -40°C - +85°C		

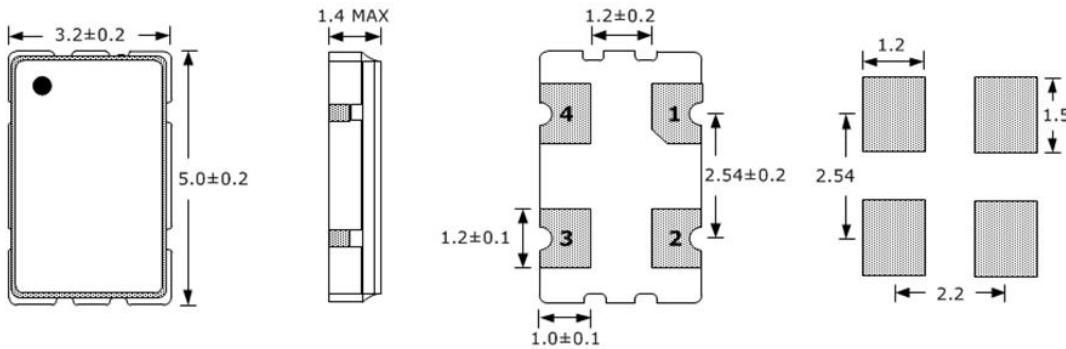
Cage Code : 4GUT4  
 To customize your parameters, contact a Suntsu representative.  
 \* For Frequency stability option D, contact a Suntsu representative.  
 \*\* For operating temperatures up to -55-125°C contact a Suntsu representative.



Electrical Parameters	Units	Minimum	Typical	Maximum	Remarks
Frequency Range	KHz	32.768			
Frequency Range	MHz	1		200	
Frequency Stability (Includes Initial Tolerance at 25°C, Frequency Stability over Operating Temperature, Output Load Change, Supply Voltage Change, and First Year Aging at 25°C.)	ppm	-20		+20	See part numbering guide for options
Operating Temperature	°C	-40		+85	See part numbering guide for options
Storage Temperature	°C	-55		+125	
Supply Voltage (V <sub>DD</sub> ) - 1.8V option	V	1.710	1.8	1.890	
Supply Voltage (V <sub>DD</sub> ) - 2.5V option	V	2.375	2.5	2.625	
Supply Voltage (V <sub>DD</sub> ) - 3.3V option	V	3.135	3.3	3.465	
<b>Frequency Range</b>		<b>1.8V</b>	<b>2.5V</b>	<b>3.3V</b>	
Current (I <sub>DD</sub> )	mA	5	5	5	Maximum Value
32.768KHz	mA	8	10	16	Maximum Value
1.0000MHz - 34.999MHz	mA	10	20	25	Maximum Value
35.000MHz - 59.999MHz	mA	25	30	40	Maximum Value
60.000MHz - 99.000MHz	mA	35	40	50	Maximum Value
100.000MHz - 160.000MHz	mA				
Output Load (CMOS)	pF			15	See part numbering guide for options
Output Logic Levels High (V <sub>OH</sub> )	V	0.9*V <sub>DD</sub>			
Output Logic Levels Low (V <sub>OL</sub> )	V			0.1*V <sub>DD</sub>	
Rise (TR) and Fall (TF) Time	ns			200	
32.768KHz	ns			10	
1.0000MHz - 34.999MHz	ns			6	
35.000MHz - 99.999MHz	ns			3	
100.000MHz - 160.000MHz	ns				
Symmetry (Duty Cycle)	%	45	50	55	
Tri-State Input Voltage - Enable	V	0.7*V <sub>DD</sub>			No Connection
Tri-State Input Voltage - Disable	V			0.3*V <sub>DD</sub>	
Start-Up Time	ms			10	
Phase Jitter (12kHz ~ 20MHz)	ps			1	

**Outline Drawing & Land Pattern**

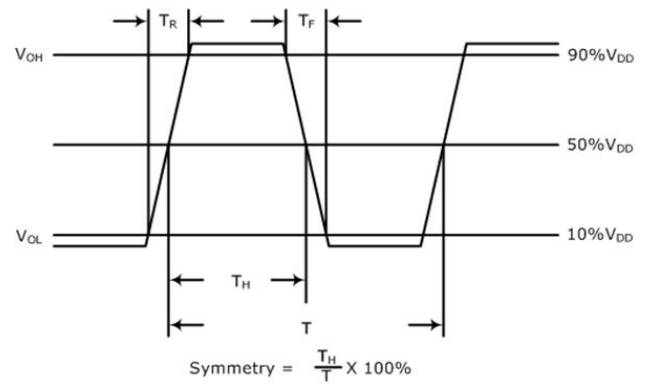
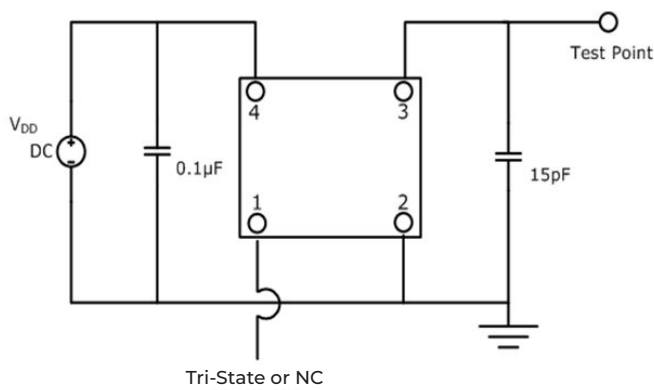
All dimensions are in millimeters (mm) unless otherwise noted. Drawings are not to scale.



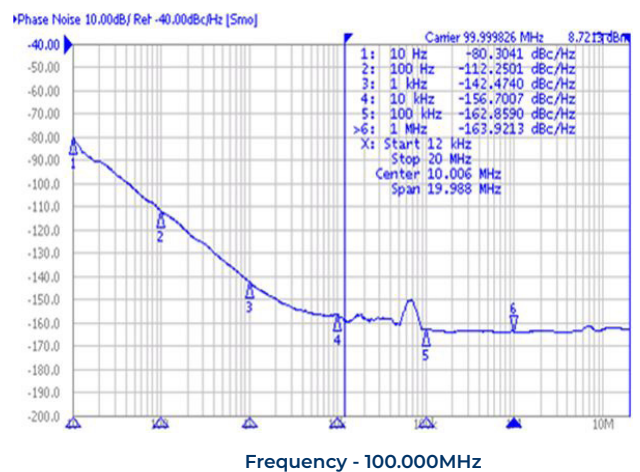
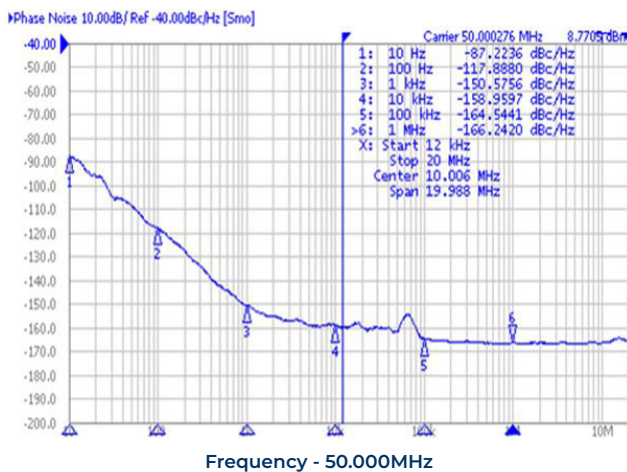
PIN	FUNCTION
1	TRI-STATE or NC
2	GND
3	OUTPUT
4	V <sub>DD</sub>

**Test Circuit (CMOS)**

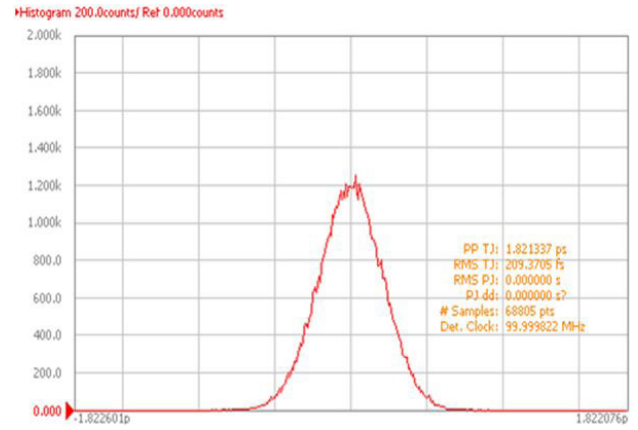
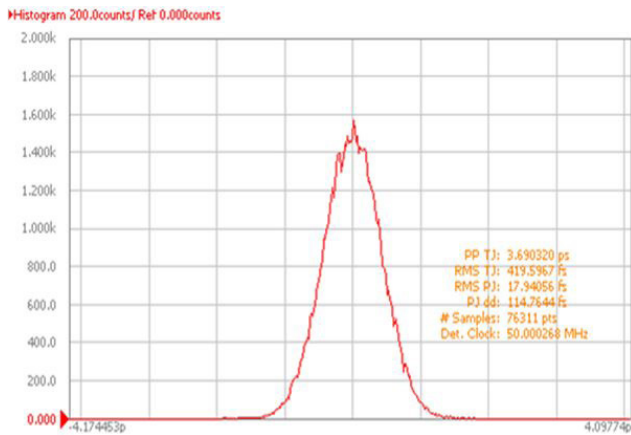
**Waveform (CMOS)**



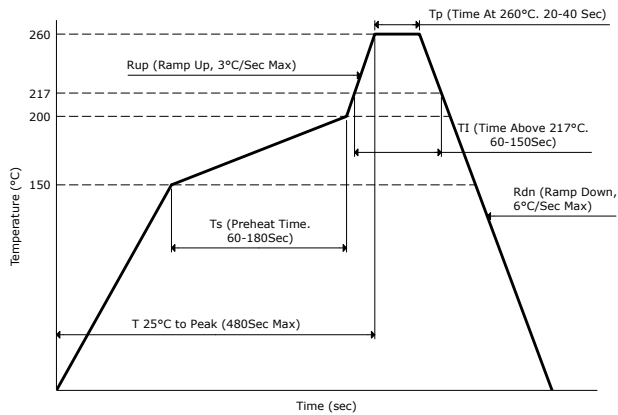
**Typical Phase Noise Performance (Measured By Agilent E5052A)**



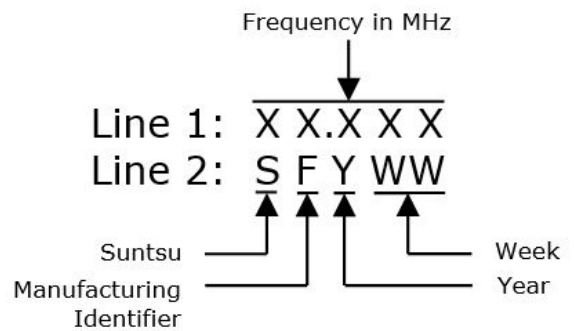
Typical Jitter Performance (Measured By Agilent E5052A)



Reflow Profile



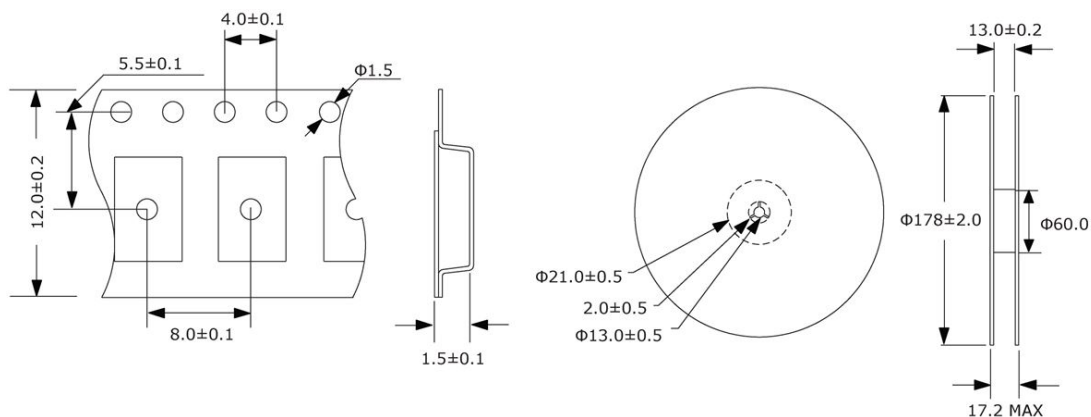
Part Marking



Tape And Reel Dimensions

All dimensions are in millimeters (mm) unless otherwise noted. Drawings are not to scale.

1,000pcs/Reel



Environmental Specifications		Mechanical Specifications	
Temperature Cycling	MIL-STD-883, Method 1010, Condition B	Mechanical Shock	MIL-STD-202, Method 213, Condition B
Fine Leak Test	MIL-STD-883, Method 1014, Condition A	Vibration	MIL-STD-883, Method 2007, Condition A
Gross Leak Test	MIL-STD-883, Method 1014, Condition C	Moisture Resistance	MIL-STD-883, Method 1004
Solderability	MIL-STD-883, Method 2003	Resistance to Solvents	MIL-STD-202, Method 215
Moisture Sensitivity	J-STD-020, MSL 1	Resistance to Soldering Heat	MIL-STD-202, Method 210, Condition K